

# **KSC5502DTTU Datasheet**



https://www.DiGi-Electronics.com

DiGi Electronics Part Number KSC5502DTTU-DG

Manufacturer onsemi

Manufacturer Product Number KSC5502DTTU

Description TRANS NPN 600V 2A TO220-3

Detailed Description Bipolar (BJT) Transistor NPN 600 V 2 A 11MHz 50 W

Through Hole TO-220-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
KSC5502DTTU	onsemi
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
NPN	2 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, Ic:
600 V	1.5V @ 200mA, 1A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
100μΑ	4 @ 1A, 1V
Power - Max:	Frequency - Transition:
50 W	11MHz
Operating Temperature:	Mounting Type:
150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-220-3	TO-220-3
Base Product Number:	
KSC5502	

# **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):		
ROHS3 Compliant	Not Applicable		
REACH Status:	ECCN:		
REACH Unaffected	EAR99		
HTSUS:			



### Is Now Part of



# ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="general-regarding-numbers-n

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products for any particular purpose, nor does ON Semiconductor assume any liability to make changes without further notice to any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expense

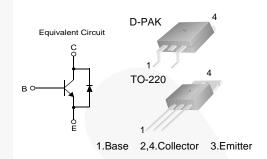


July 2014

# **KSC5502D / KSC5502DT NPN Triple Diffused Planar Silicon Transistor**

#### **Features**

- · High Voltage Power Switch Switching Application
- · Wide Safe Operating Area
- · Built-in Free-Wheeling Diode
- Suitable for Electronic Ballast Application
- Small Variance in Storage Time
- Two Package Choices: D-PAK or TO-220



### **Ordering Information**

Part Number	Top Mark	Package	Packing Method	
KSC5502DTM	C5502D	TO-252 3L (DPAK)	Tape and Reel	
KSC5502DTTU	C5502D	TO-220 3L	Rail	

#### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_C = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	1200	V
V <sub>CEO</sub>	Collector-Emitter Voltage	600	V
V <sub>EBO</sub>	Emitter-Base Voltage	12	V
I <sub>C</sub>	Collector Current (DC)	2	А
I <sub>CP</sub>	Collector Current (Pulse) <sup>(1)</sup>	4	Α
I <sub>B</sub>	Base Current (DC)	1	Α
I <sub>BP</sub>	Base Current (Pulse) <sup>(1)</sup>	2	Α
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to 150	°C
EAS	Avalanche Energy (T <sub>J</sub> = 25°C)	2.5	mJ

#### Note

1. Pulse test: Pulse width = 5 ms, duty cycle  $\leq$  10%.

# **Thermal Characteristics**

Values are at  $T_C = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	KSC5502D (D-PAK)	KSC5502DT (TO-220)	Unit
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> = 25°C)	87.83 118.16 W		W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.42 1.06 °C/W		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	111.0 62.5		°C/W
TL	Maximum Lead Temperature for Soldering Purpose: 1/8 inch from Case for 5 seconds	270		°C

## **Electrical Characteristics**

Values are at  $T_C = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Unit
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 1 \text{ mA}, I_E = 0$	$I_C = 1 \text{ mA}, I_E = 0$		1350		V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 5 mA, I <sub>B</sub> = 0		600	750		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 500  \mu A,  I_C = 0$		12.0	13.7		V
4	Collector Cut-off Current	V <sub>CES</sub> = 1200 V, V <sub>BE</sub> = 0	$T_C = 25^{\circ}C$			100	^
I <sub>CES</sub>	Collector Cut-on Current	V <sub>CES</sub> = 1200 v, v <sub>BE</sub> = 0	T <sub>C</sub> = 125°C			500	μΑ
1	Collector Cut-off Current	$V_{CE} = 600 \text{ V}, I_{B} = 0$	$T_C = 25^{\circ}C$			100	μΑ
ICEO	Collector Cut-on Current	v <sub>CE</sub> = 600 v, i <sub>B</sub> = 0	T <sub>C</sub> = 125°C	1		500	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = 12 \text{ V}, I_{C} = 0$	$T_C = 25^{\circ}C$			10	μΑ
		$V_{CE} = 1 \text{ V, } I_{C} = 0.2 \text{ A}$	$T_C = 25^{\circ}C$	15	28	40	
		$V_{CE} = 1$ V, $I_C = 0.2$ A	T <sub>C</sub> = 125°C	8	18		
h	DC Current Gain	$V_{CE} = 1 \text{ V, } I_{C} = 1 \text{ A}$	$T_C = 25^{\circ}C$	4.0	6.4		
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 1 A	T <sub>C</sub> = 125°C	3.0	4.7		
		V <sub>CE</sub> = 2.5 V,	$T_C = 25^{\circ}C$	12	20	30	
		$I_C = 0.5 A$	T <sub>C</sub> = 125°C	6	12		
	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 0.2 A, I <sub>B</sub> = 0.02 A	$T_C = 25^{\circ}C$		0.31	0.80	V
			T <sub>C</sub> = 125°C		0.54	1.10	
\/ (oot)		I <sub>C</sub> = 0.4 A, I <sub>B</sub> = 0.08 A	$T_C = 25^{\circ}C$	A	0.15	0.60	
V <sub>CE</sub> (sat)			T <sub>C</sub> = 125°C		0.23	1.00	
		I <sub>C</sub> = 1 A, I <sub>B</sub> = 0.2 A	$T_C = 25^{\circ}C$		0.40	1.50	
			T <sub>C</sub> = 125°C		1.30	3.00	
		I <sub>C</sub> = 0.4 A, I <sub>B</sub> = 0.08 A	T <sub>C</sub> = 25°C		0.77	1.00	
\/ (aat)	Dage Emitter Caturation Valtage		T <sub>C</sub> = 125°C		0.60	0.90	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage		$T_C = 25^{\circ}C$		0.83	1.20	V
		$I_C = 1 \text{ A}, I_B = 0.2 \text{ A}$	T <sub>C</sub> = 125°C		0.70	1.00	
C <sub>ib</sub>	Input Capacitance	V <sub>EB</sub> = 8 V, I <sub>C</sub> = 0, f = 1 MHz			385	500	pF
C <sub>ob</sub>	Output Capacitance	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$			60	100	pF
f <sub>T</sub>	Current Gain Bandwidth Product	$I_C = 0.5 \text{ A,V}_{CE} = 10 \text{ V}$			11		MHz
	Diode Forward Voltage	I <sub>F</sub> = 0.2 A	T <sub>C</sub> = 25°C		0.75	1.20	
V <sub>F</sub> [			T <sub>C</sub> = 125°C		0.59		
		I <sub>F</sub> = 0.4 A	T <sub>C</sub> = 25°C		0.80	1.30	V
			T <sub>C</sub> = 125°C		0.64		
		I <sub>F</sub> = 1 A	T <sub>C</sub> = 25°C		0.90	1.50	

# **Electrical Characteristics**

Values are at  $T_C = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Conditions		Min	Тур.	Max.	Unit
	5	I <sub>F</sub> = 0.2 A			650		
t <sub>fr</sub>	t <sub>fr</sub> Diode Froward Recovery Time (di/dt=10 A/μs)	I <sub>F</sub> = 0.4 A			740		ns
	Time (divat=10 A/µ3)	I <sub>F</sub> = 1 A			785		
		$I_C = 0.4 \text{ A}, I_{B1} = 80 \text{ mA},$	at 1 μs		7.2		
\/ (DCAT)	Dunamia Caturation Valtage	$V_{CC} = 300 \text{ V}$	at 3 μs		1.8		V
V <sub>CE</sub> (DSAT)	Dynamic Saturation Voltage	$I_C = 1 \text{ A}, I_{B1} = 200 \text{ mA},$	at 1 μs		18.0		
		$V_{CC} = 300 \text{ V}$	at 3 μs		6.0		
Resistive L	oad Switching (D.C < 10%, Pt	ulse Width = 20 s)					
4	Turn-On Time		T <sub>C</sub> = 25°C		175	350	no
t <sub>ON</sub>	Turn-On Time	$I_C = 0.4 \text{ A}, I_{B1} = 80 \text{ mA},$	T <sub>C</sub> = 125°C		185		ns
. /	Turn Off Time	$I_{B2} = 0.2 \text{ A}, V_{CC} = 300 \text{ V},$ $R_{I} = 750 \Omega$	$T_C = 25^{\circ}C$		2.1	3.0	μs
UFF	t <sub>OFF</sub> Turn-Off Time		T <sub>C</sub> = 125°C		2.6		
. /	. /	I <sub>C</sub> = 1 A, I <sub>B1</sub> = 160 mA,	T <sub>C</sub> = 25°C		240	450	
t <sub>ON</sub> Turn-On Time	$I_{B2} = 160 \text{ mA},$	T <sub>C</sub> = 125°C		310		ns	
_	t <sub>OFF</sub> Turn-Off Time	$V_{CC} = 300 \text{ V},$	T <sub>C</sub> = 25°C		3.7	5.0	μs
UOFF			T <sub>C</sub> = 125°C		4.5		
Inductive L	oad Switching (V <sub>CC</sub> = 15 V)						
4	Storage Time		T <sub>C</sub> = 25°C		1.2	2.0	μs
t <sub>STG</sub>	Storage Time		T <sub>C</sub> = 125°C		1.5		
+	Fall Time	$I_C = 0.4 \text{ A}, I_{B1} = 80 \text{ mA},$	$T_C = 25^{\circ}C$		90	200	20
t <sub>F</sub>	raii IIIIle	$I_{B2} = 0.2 \text{ A}, V_Z = 300 \text{ V},$ $L_C = 200 \text{ H}$	T <sub>C</sub> = 125°C		65		ns
	Cross Over Time	-20-11	T <sub>C</sub> = 25°C		185	350	ns
$t_{C}$	Cross-Over Time		T <sub>C</sub> = 125°C		145		
4	Ctorogo Timo		T <sub>C</sub> = 25°C		3.30	4.50	
t <sub>STG</sub>	Storage Time	I <sub>C</sub> = 0.8 A, I <sub>B1</sub> = 160 mA,	T <sub>C</sub> = 125°C		3.75		μs
+	t <sub>F</sub> Fall Time	$I_{B2} = 160 \text{ mA},$	$T_C = 25^{\circ}C$		90	250	nc
ŀF		$V_{CC} = 300 \text{ V},$	T <sub>C</sub> = 125°C		160		ns
+	A Cross such Time	L <sub>C</sub> = 200 H	$T_C = 25^{\circ}C$		300	600	nc
t <sub>C</sub> Cross-over Time	Cioss-over fillie		T <sub>C</sub> = 125°C		570	ns	

## **Typical Performance Characteristics**

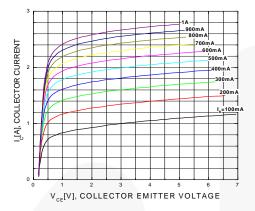


Figure 1. Static Characteristic

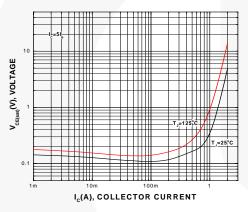


Figure 3. Collector-Emitter Saturation Voltage

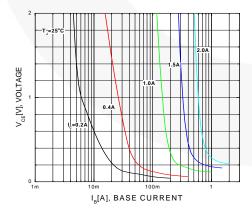


Figure 5. Typical Collector Saturation Voltage

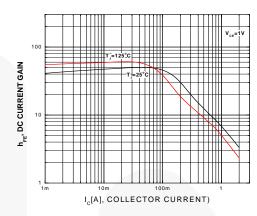


Figure 2. DC Current Gain

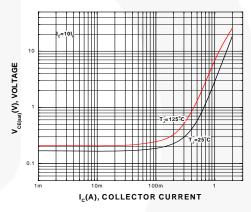


Figure 4. Collector-Emitter Saturation Voltage

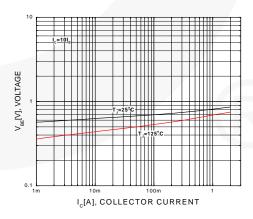


Figure 6. Base-Emitter Saturation Voltage

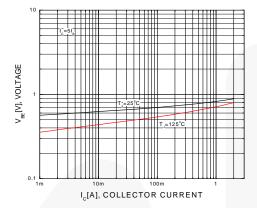


Figure 7. Base-Emitter Saturation Voltage

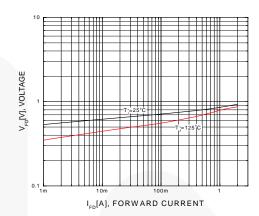


Figure 8. Diode Forward Voltage

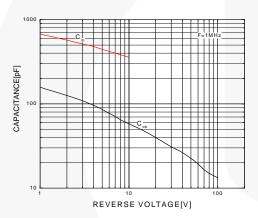


Figure 9. Collector Output Capacitance

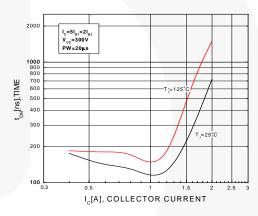


Figure 10. Resistive Switching Time, ton

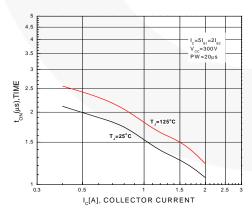


Figure 11. Resistive Switching Time, toff

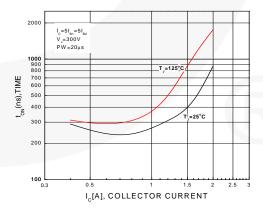


Figure 12. Resistive Switching Time, ton

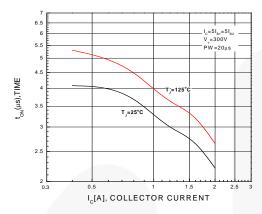


Figure 13. Resistive Switching Time, toff

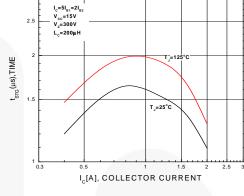


Figure 14. Inductive Switching Time, t<sub>STG</sub>

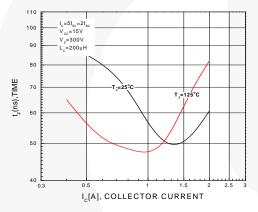


Figure 15. Inductive Switching Time, t<sub>F</sub>

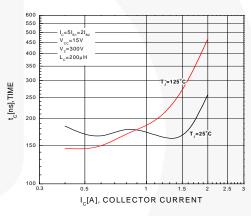


Figure 16. Inductive Switching Time, t<sub>c</sub>

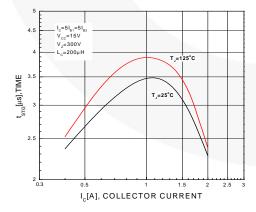


Figure 17. Inductive Switching Time, t<sub>STG</sub>

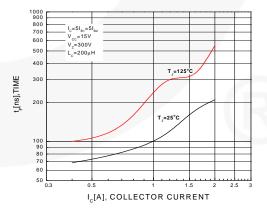


Figure 18. Inductive Switching Time, t<sub>F</sub>

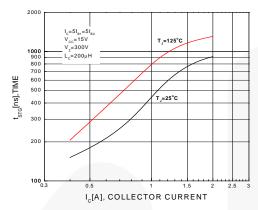


Figure 19. Inductive Switching Time, tc

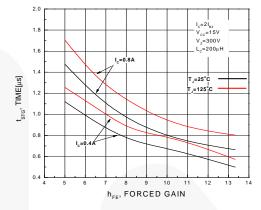


Figure 20. Inductive Switching Time, t<sub>STG</sub>

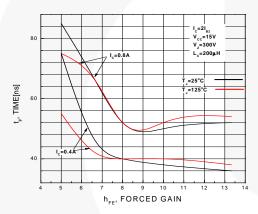


Figure 21. Inductive Switching Time, t<sub>F</sub>

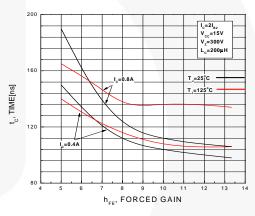


Figure 22. Inductive Switching Time, t<sub>c</sub>

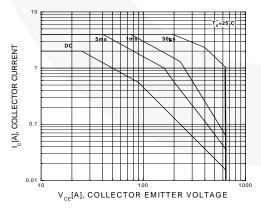


Figure 23. Forward Bias Safe Operating Area

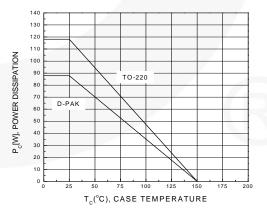
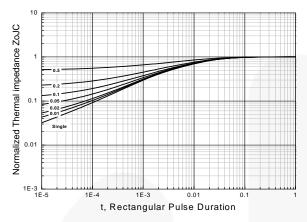


Figure 24. Power Derating



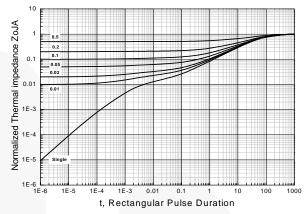
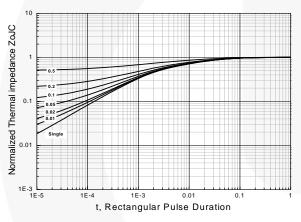


Figure 25. ZoJC, Transient Thermal Impedance (D-PAK)

Figure 26. ZoJA, Transient Thermal Impedance (D-PAK)



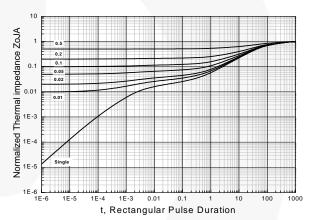


Figure 27. ZoJC, Transient Thermal Impedance (TO-220)

Figure 28. ZoJA, Transient Thermal Impedance (TO-220)

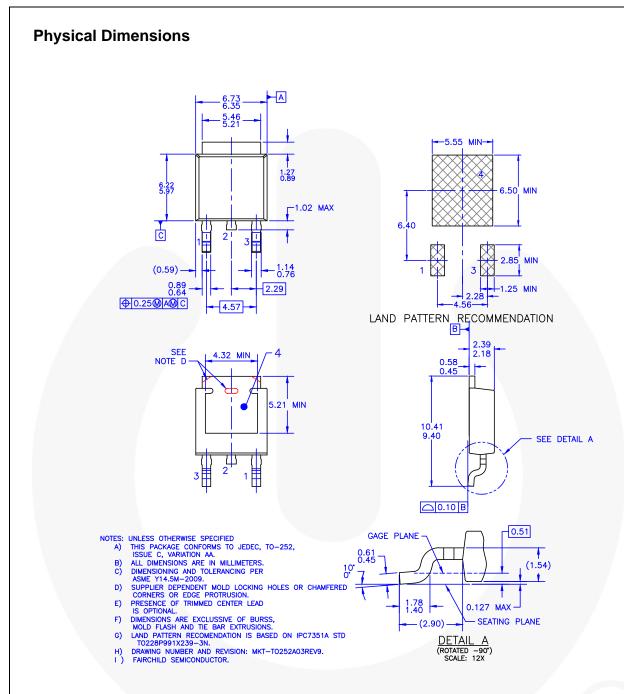


Figure 29. TO-252 (D-PAK), MOLDED, 3-LEAD, OPTION AA & AB

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/dwg/TO/T0252A03.pdf">http://www.fairchildsemi.com/dwg/TO/T0252A03.pdf</a>.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/packing\_dwg/PKG-TO252A03.pdf">http://www.fairchildsemi.com/packing\_dwg/PKG-TO252A03.pdf</a>.

# **Physical Dimensions** SUPPLIER "B" PACKAGE SHAPE Ø 3 50 10.67 9.65 SUPPLIER "A" PACKAGE 3.40 2.50 IF PRESENT, SEE NOTE 'D" A 9.40 [2.46] С FRONT VIEWS 1.62 1.42 OPTIONAL CHAMFER NOTE "I" BOTTOM VIEW NOTES: A) REFERENCE JEDEC, TO-220, VARIATION AB B) ALL DIMENSIONS ARE IN MILLIMETERS. B) ALL DIMENSIONS ARE IN MILLIMETERS. C) DIMENSIONS COMMON TO ALL PACKAGE SUPPLIERS EXCEPT WHERE NOTED [ ]. D) LOCATION OF MOLDED FEATURE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE) LODGE NOT COMPLY JEDEC STANDARD VALUE. F) "A1" DIMENSIONS AS BELOW: SINGLE GAUGE = 0.51 - 0.61 DUAL GAUGE = 1.10 - 1.45 D) DRAWING FILE NAME: TO220803REV8 PRESENCE IS SUPPLIER DEPENDENT SUPPLIER DEPENDENT MOLD LOCKING HOLES IN HEATSINK J) FAIRCHILD SEMICONDUCTOR

Figure 30. TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/TO/TO220B03.pdf.

**BACK VIEW** 

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing\_dwg/PKG-TO220B03.pdf.

SIDE VIEW





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

F-PFS™ AccuPower™ AX-CAP®, FRFET® RitSiC™ Global Power Resource<sup>SM</sup> GreenBridge™ Build it Now™  $CorePLUS^{\tiny{\mathsf{TM}}}$ Green FPS™ CorePOWFR™ Green FPS™ e-Series™ CROSSVOLT™ Gmax™ GTO™ CTL™

Current Transfer Logic™ IntelliMAX™

DEUXPEED® ISOPLANAR™

Dual Cool™ Making Small S

 Dual Cool™
 Making Small Speakers Sound Louder

 EcoSPARK®
 and Better™

ESBC™ MICROCOUPLER™

MicroFET™
MicroPak™

Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™
FastvCore™
FETBench™

FAIRCHILD MIGROPAL2™
MillerDrive™
MotionMax™
mWSaver®
OptoHITM
OPTOLOGIC®
OPTOPLANAR®

PowerTrench® PowerXS™

Programmable Active Droop™

QFET<sup>®</sup>
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SuperSOT™-8
SupreMOS®

SyncFET™ Sync-Lock™ SYSTEM GENERAL®\*

TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™
TriFault Detect™

Transic.™
TriFault Detect™
TRUECURRENT®\*
µSerDes™

SerDes® UHC® Ultra FRFET™ VCX™ VisualMax™ VoltagePlus™ XS™ 仙童™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

		5.6.11
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 168

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

ON Semiconductor and III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="https://www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages.

Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative



# **OUR CERTIFICATE**

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

















Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com